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 electronic card assembly can resist a bend of greater than 10° during a torque test applying a torque of greater than approximately 1.2 N-m; deflects less than approximately 3.5mm during a PCMCIA bend test applying a force of approximately 20N; and displaces less than approximately 1.5mm during a fingernail test applying a force of more than approximately 100N. Such test performance is achieved even without a printed circuit board in the electronic card assembly.- -

IN THE CLAIMS:

Please cancel claims 40-45.

Please add the following claims:

 46. (New) In an electronic card assembly, wherein the improvement comprises said electronic card assembly withstanding rotating to an of greater than approximately 10° during a torque test which applies a torque of greater than approximately 1.2 N-m.

47. (New) The electronic card assembly according to claim 46 wherein said electronic card assembly can withstand rotating to an angle of approximately 12°.

48. (New) The electronic card assembly as recited in claim 47, wherein the electronic card assembly does not include a printed circuit board during the torque test.

49. (New) In an electronic card assembly, wherein the improvement comprises said electronic card assembly deflecting less than the PCMCIA standard during a PCMCIA bend test which applies a force of approximately 20N.